

## LSST Large Synoptic Survey Telescope



R. Van Berg January 18, 2011





- syn-op-tic (s-nptk) also syn-op-ti-cal (-t-kl)adj.
- 1. Of or constituting a synopsis; presenting a summary of the principal parts or a general view of the whole.

#### συνοπτικοσ

#### Preface Introduction LSST System Design System Performance **Education and Public Outreach** The Solar System **Stellar Populations** Milky Way & Local Volume Structure The Transient & Variable Universe Galaxies Active Galactic Nuclei Dark Energy Supernovae Strong Lenses Large-Scale Structure Weak Lensing **Cosmological Physics**

www.lsst.org/lsst/scibook



Penn S



"The committee recommends that LSST be submitted immediately for NSF's Major Research Equipment and Facilities Construction (MREFC) consideration with a view to achieving first light before the end of the decade.

The top rank accorded to LSST is a result of (1) its compelling science case and capacity to address so many of the science goals of this survey and (2) its readiness for submission to the MREFC process as informed by its technical maturity, the survey's assessment of risk, and appraised construction and operations costs. Having made considerable progress in terms of its readiness since the 2001 survey, the committee judged that LSST was the most ready-to-go."

August 13, 2010





NSF

- Telescope & Site
  - Telescope Mount
  - Mirrors (M1, M2, M3)
  - Observatory + base facility +....
- Data Management
  - Data movement, storage, analysis
- Camera
  DOE
  - Lenses, filters, sensors, electronics, etc.







#### The LSST Telescope





#### **Telescope Optics**





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#### **Primary/Tertiary Mirror (in fabrication)**





#### Large machinery, large piece of glass, nm precision





The Telescope and Site includes the summit and base facilities, telescope system, & calibration hardware





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## Summit facility final design under contract with ARCADIS Geotecnica, Santiago Chile





## **Telescope Dome – an interesting set of challenges**









M57

**Telescope Mount** 



Moving structure: 300 tons

Drive power: 450 hp

**Damping: Tuned masses raise damping to 5%** 

First Frequency: 8.2 hz (loaded structure on bearings, pier, and summit rock)





#### M1M3 System





#### **Mirror supports and actuators**





#### M2 Substrate purchased and completed by Corning using LSST non-federal funding









Hickson92



- Data from Camera
  - 3 GigaPixels, 2 Bytes/Pixel = 6GB every 18 s (no "Trigger"!!!)
  - 1200 GB / hour  $\rightarrow$  12 TB / observing night (ATLAS ~ 16TB/day)
- However, LSST must do fast alerts to Astronomical Community!
  Image stream from camera generates real-time transient alerts
  - Difference image based
  - 60s latency, requires ~37 TFLOPS
- Process <u>entire</u> survey data annually to produce a Data Release
  - Self consistent set of data products, all w/same algorithms
  - Full survey depth to SRD requirements
  - 68 PB images in survey year 10, requires ~ 300 TFLOPS
- Produce calibration data products needed by above
  - Support challenging SRD photometry requirements

#### Data Management II



- Make data available to scientists, with enough processing cycles and support to make it useful
  - ~57 TFLOPS, 13 PB storage dedicated for users



Processed from single full Imsim focalplane, binned 4x4, with the markings for the individual amplifiers, ccds.

#### **Data Management World View**









M15

### The Camera.....



- 3.2 Gigapixels
- 0.2 arcsec pixels
- 9.6 square degree FOV
- 2 second readout

1.65 m 5'-5"

6 filters \_\_\_\_

Farameter	value
Diameter	1.65 m
Length	3.7 m
Weight	3000 kg
F.P. Diam	634 mm

#### Unique technical challenges drive camera design

- Very large field of view (9.6 square degree FOV) implies a physically large focal plane (64-cm diameter) with small (10 μm) pixels
- Fast f/1.2 beam leads to short depthof-focus
- Broad spectral coverage (350 – 1040nm)
- Fast readout to maintain high efficiency given the short exposures (3.2 Gigapixels in 2 seconds)
- Large number of signal lines and large cryostat & low noise
- Camera located in the telescope beam

- Mosaic of a large number (189) of sensors with narrow interchip gaps (250 μm)
- ⇒ Tight alignment and flatness tolerances (15 µm p-to-v) on the sensor array
- ⇒ Deep, fully depleted CCDs, but with minimal charge spreading; 6 filters
- ⇒ Parallelized design and sensors which are highly segmented (16 readout ports)
- ⇒ Electronics must be implemented in the cryostat
- ⇒ Tight constraints on envelope, mass, & heat dissipation



## Integrated complex sub-systems tightly packaged within the telescope's optical constraints





#### Walk-through 1: Overall view





## Walkthrough 2: Camera partial assembly showing Auto Changer





## Walkthrough 3: Camera partial assembly showing Shutter





## Walkthrough 4: Camera partial assembly showing Carousel, Cryostat, and detector plane past L3 lens





## Walkthrough 5: Cryostat section showing detectors, structure and thermal control elements





## The Sensors subsystem consists of the 21 "science rafts" that make up the 3.2Gpix focal plane









M1

**CCDs** 



- Charge Coupled
  Devices
  - Willard Boyle, George Smith (invented 1969, Nobel 2009)
- Areal array
  - "parallel shifts" data to output register (2k)
  - "serial shifts" data to electronics (512)



#### **CCD Challenges**



Large field of view implies physically large focal plane (64cm $\Phi$ )	Modular mosaic focal plane construction	21 rafts × 9 4K CCDs/raft 189 CCDs total 3.1Gpix
Fast f/1.2 beam, shallow depth of focus	Tight alignment and flatness tolerance	Flatness: 5µm Alignment (z axis): 10µm
Plate scale 20"/mm	Small pixels, close butting	Pixel: 10μm Chip-chip gap: 250μm
Fast readout (2s) with low noise (5 e <sup>-</sup> )	Highly parallel readout electronics	16 amplifiers/4K CCD
Broadband, high spectral sensitivity	Thick silicon sensor, back illuminated, AR coat	100µm thickness for IR sensitivity Thin conductive window
Seeing-limited image quality	Internal electric field to minimize diffusion	High resistivity, biased silicon (> 3 k $\Omega$ -cm, -50V)

#### LSST's high throughput goals

- The largest focal plane
  - LSST:
  - PanSTARRS GPC1: 1.4Gpix (60 CCDs)
  - HyperSuprimeCam: 940Mpix (112 CCDs)
  - DECam: 500Mpix (60 CCDs)
  - (36 CCDs) – CFHT MegaCam: 340Mpix
- The fastest focal ratio •

_	LSST:	f/1.23
_	SuprimeCam:	f/1.87
_	DECam:	f/2.7

- DECam. – PanSTARRS: f/4
- CFHT MegaCam: f/4.2
- The fastest readout time
  - LSST: 2s
  - PanSTARRS GPC1: 6s
  - DECam: 17s
  - CFHT MegaCam: 40s
  - Suprime-Cam: 18s



MegaCam









GPC1

3.2Gpix (189 CCDs)

#### The 4K x 4K LSST sensor reference design











Thick, high-ρ bulk Si	100μm, > 3kΩ-cm
Highly transmissive, biased window	<<10nm, -50V
Flat Si surface	5µm peak-valley
Package dimensional control	∥ optic axis: 1.5μm ⊥ optic axis: 5μm Chip-chip gap 250μm Thermally stable
Parallel, multiport readout	16 amplifiers
Low-noise outputs	< 6e <sup>-</sup> at 500kHz
Reproducible and high yield	No individual device tuning

semiconductor

mechanics

amplifiers

production

#### **Edge effects**





#### Phase 1 device tests -- laboratory





#### Charge diffusion (xray PSF)





#### **Phase 1 sensor flatness**





measurements by P. Takacs, BNL





#### A CCD Electrically.....









#### NGC891

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#### Highly integrated, in-cryostat electronics



- Total of 3.024Gpix in focal plane
- Goal is 2s readout with 6e- noise
- CCD readout rate must be below ~600kHz to achieve noise figure
  - → CCDs must be segmented into 1-Mpix segments with individual readout amplifiers
- Choose 4Kx4K CCD format with 16 2048 x 512 pixel segments
  - Total wire count to CCDs ~15,000
- Impractical to take this many wires through vacuum barrier
  →Implement compact (ASIC-based) electronics chain in cryostat

#### ASPIC (video processing)

#### SCC (clock/bias generation)







#### **Raft-Centric Electronics System**





#### ASPIC Specifications – IN2P3\* (Analog Signal Processing Integrated Circuit)



- Operates at a temperature of 173K
- Noise :
  - en < 5nV/sqrt(Hz) maximum noise density</li>
  - enc <  $7\mu$ Vrms maximum input noise @ 500ns integration time (~2e<sup>-</sup>)
  - Note : Either or both of the above may be met. If, for example, at very long integration time, en will rise but enc will fall, and still be an advantage.
- Operation @ 250kHz to 500kHz
- 0.05% maximum crosstalk between channels @ 500kHz
- 100k e<sup>-</sup> full well capacity (350 to 400 mV maximum input)
- 0.5% linearity (defined over 0 to 100k e<sup>-</sup>)
- Differential output
- Output load 50pF // 1k
- Power supply 5V / Gnd reference Vref = 2.5V
- Power dissipation 25mW / channel
- The ASPIC is designed in 0.35µm 5V CMOS technology from AMS.

#### ASPIC – Correlated Double Sampler / Dual Slope Integrator





#### SCC - ORNL (Sensor Control Chip)



🔆 Agilent Technologies			Agilent Technologies		
1 5.00V/	로 229날 200달/ Auto	<b>F 1</b> 7.19V <b>1</b> 5.00	₩/	<b>_ 1.38</b> ਾੂ 200ਞੁ∕	Auto 🗲 1 14.5V
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	‡   <b>[</b> 1	₽		Rise	1): 6us
	<i></i>	L		FallC	1): 6us
1 ₽				Freq	( <u>1</u> ): 1.667kHz
Fall(1): 34ns Rise(1):	37ns [Freq(1): 1	.043MHz Print	to disk file: [PRINT_00]		
Source Select: Measure 1 Freq Freq	Clear Settings Meas	Ca	ncel int		

	Load	Frequency	Rise Time	Fall Time
Switch 1_2	340 pF	1 MHz	35.5 ns	32.5 ns

	Load	Freq	Rise Time	Fall Time
Switch 1_4	95 nF	1.6 kHz	7.3 us	7.5 us

#### **Front End Board - Penn**

To CCDs



3 ASPICs 6 SCCs (24 Channels) 0 0 . . . . . . . 0 .............. 00000 

To BEBs

#### **Back End Board - Harvard**





#### **Raft Control Module - Harvard**





#### "Vertical Slice Tests" – Penn – ASPIC2







**ASPC-1** 



DSI\_Out Gain:

75 µV per count

Gain (Input vs. Output):

4.6 mV out per mV in



#### "Vertical Slice Test" - Harvard







- Power Supplies
- Electro-Optical Converters (DAQ)
- Clock generation and distribution
- Controls for:
  - Shutter
  - Filters
  - Pumps
  - Cooling

#### Location, Location, Location





#### How to annoy traditionalists....





#### Things not mentioned....



- Thermal design
- Grounding & Shielding
- Optical design / filter characteristics
- Camera and Observatory Control Systems
- Data Acquisition System
- Data bases meta-data for everything
- Image processing (data cleaning and frame co-adding)
- Vacuum design
- Cleanliness, contamination control
- Focal Plane alignment (ppm!)
- Metrology
- Mechanical design
- Calibration
- Observing simulator / planner





#### First Light – 2018???



# Synoptic!

#### Backup.....



#### **LSST Boxes**





#### **Camera Boxology**





# Calyspo has an LSST test camera installed with phase 1 prototype sensor



- LSST's 1.2 meter diameter Telescope on Kitt Peak
- Observing Operations conducted regularly
- LSST U, Y3, and Y4 as well as Sloan filter set on telescope





ITL/STA 1920A at Calypso

M1 (R band, 4Kx4K)



#### **Data Management III**





LSST PT1 Raw Amp Exposure Metadata for ImSim SLAC production run

310

64208

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